

NP75N055YUK

55 V - 75 A - N-channel Power MOS FET Application: Automotive

R07DS1005EJ0100 Rev.1.00 Feb 08, 2013

Description

The NP75N055YUK is N-channel MOS Field Effect Transistors designed for high current switching applications.

Features

- Super low on-state resistance $R_{DS(on)} = 4.5 \ m\Omega \ MAX. \ (V_{GS} = 10 \ V, \ I_D = 38 \ A)$
- Non logic level drive type
- Designed for automotive application and AEC-Q101 qualified

Ordering Information

Part No.	Lead Plating	Pac	Package	
NP75N055YUK-E1-AY *1	Pure Sn (Tin)	Tape 2500 p/reel	Taping (E1 type)	8-pin HSON
NP75N055YUK-E2-AY *1			Taping (E2 type)	

Note: *1 Pb-free (This product does not contain Pb in the external electrode)

Absolute Maximum Ratings $(T_A = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to Source Voltage (V _{GS} = 0 V)	V _{DSS}	55	V
Gate to Source Voltage (V _{DS} = 0 V)	V _{GSS}	±20	V
Drain Current (DC) (T _C = 25°C)	I _{D(DC)}	±75	Α
Drain Current (pulse) *1	I _{D(pulse)}	±225	Α
Total Power Dissipation (T _C = 25°C)	P _{T1}	138	W
Total Power Dissipation (T _A = 25°C) *2	P _{T2}	1.0	W
Channel Temperature	T _{ch}	175	°C
Storage Temperature	T _{stg}	-55 to +175	°C
Repetitive Avalanche Current *3	I _{AR}	32	Α
Repetitive Avalanche Energy *3	E _{AR}	102	mJ

Notes: *1 $T_C = 25$ °C, $P_W \le 10 \mu s$, Duty Cycle $\le 1\%$

Thermal Resistance

^{*2} Mounted on glass epoxy substrate of 40 mm \times 40 mm \times 1.6 mmt with 4% Copper area (35 μ m)

^{*3} $R_G = 25 \Omega$, $V_{GS} = 20 V \rightarrow 0 V$

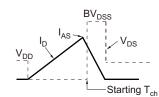
Electrical Characteristics (T_A = 25°C)

Item	Symbol	MIN.	TYP.	MAX.	Unit	Test Conditions
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 55 \text{ V}, V_{GS} = 0 \text{ V}$
Gate Leakage Current	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$
Gate to Source Threshold Voltage	$V_{GS(th)}$	2.0	3.0	4.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
Forward Transfer Admittance *1	y _{fs}	30	60	_	S	$V_{DS} = 5 \text{ V}, I_{D} = 38 \text{ A}$
Drain to Source On-state Resistance *1	R _{DS(on)}	_	3.6	4.5	mΩ	$V_{GS} = 10 \text{ V}, I_D = 38 \text{ A}$
Input Capacitance	C _{iss}	_	3500	5300	pF	V _{DS} = 25 V
Output Capacitance	Coss	_	360	540	pF	$V_{GS} = 0 V$
Reverse Transfer Capacitance	C _{rss}	_	140	250	pF	f = 1 MHz
Turn-on Delay Time	t _{d(on)}	_	24	48	ns	$V_{DD} = 28 \text{ V}, I_{D} = 38 \text{ A}$
Rise Time	t _r	_	7	17	ns	V _{GS} = 10 V
Turn-off Delay Time	t _{d(off)}	_	60	120	ns	$R_G = 0 \Omega$
Fall Time	t _f	_	5	13	ns	
Total Gate Charge	Q_G	_	55	83	nC	V _{DD} = 44 V
Gate to Source Charge	Q_{GS}	_	16	_	nC	V _{GS} = 10 V
Gate to Drain Charge	Q_{GD}	_	13	_	nC	$I_D = 75 A$
Body Diode Forward Voltage *1	$V_{F(S-D)}$	_	0.9	1.5	V	I _F = 75 A, V _{GS} = 0 V
Reverse Recovery Time	t _{rr}	_	42	_	ns	$I_F = 75 \text{ A}, V_{GS} = 0 \text{ V}$
Reverse Recovery Charge	Q _{rr}	_	56	_	nC	di/dt = 100 A/μs

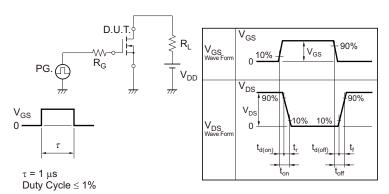
Note: *1 Pulsed test

TEST CIRCUIT 1 AVALANCHE CAPABILITY

$V_{GS} = 20 \rightarrow 0 \text{ V}$ $V_{GS} = 20 \rightarrow 0 \text{ V}$ V_{DD} V_{DD} V_{DD}



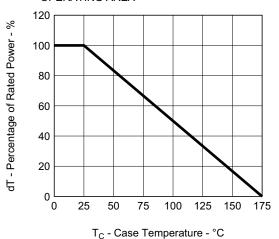
TEST CIRCUIT 2 SWITCHING TIME



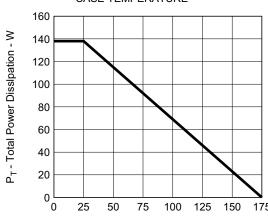
TEST CIRCUIT 3 GATE CHARGE

Typical Characteristics $(T_A = 25^{\circ}C)$

DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA

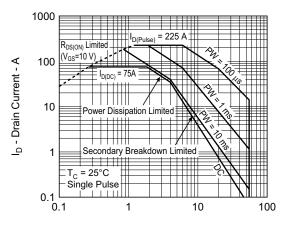


TOTAL POWER DISSIPATION vs. CASE TEMPERATURE



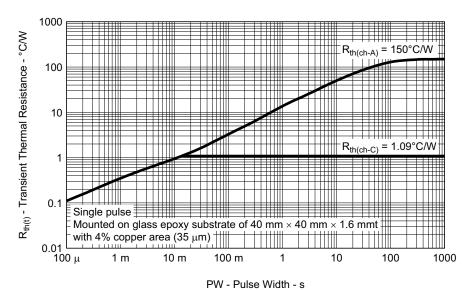
T_C - Case Temperature - °C

FORWARD BIAS SAFE OPERATING AREA



 V_{DS} - Drain to Source Voltage - V

TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



0

V_{GS(th)} - Gate to Source Threshold Voltage - V

 $R_{DS(on)}$ - Drain to Source On-State Resistance - $m\Omega$

0

0.2

0.4

DRAIN TO SOURCE VOLTAGE 250 200 150 150 50

DRAIN CURRENT vs.

V_{DS} - Drain to Source Voltage - V

0.8

0.6

 $V_{GS} = 10 \text{ V}$

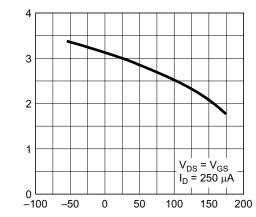
1.2

1.4

Pulsed

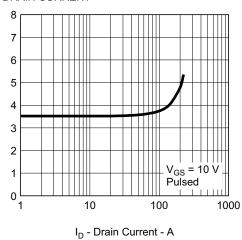
1.0

GATE TO SOURCE THRESHOLD VOLTAGE vs. CHANNEL TEMPERATURE

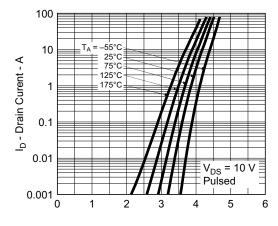


T_{ch} - Channel Temperature - °C

DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

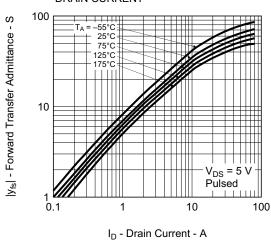


FORWARD TRANSFER CHARACTERISTICS

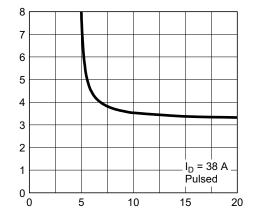


V_{GS} - Gate to Source Voltage - V

FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

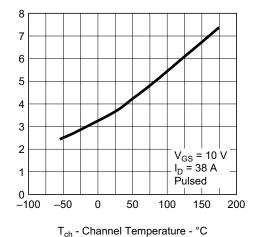


V_{GS} - Gate to Source Voltage - V

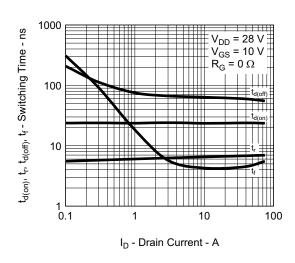
 $R_{\text{DS(on)}}$ - Drain to Source On-State Resistance - $m\Omega$

 $R_{DS(on)}$ - Drain to Source On-State Resistance - $m\Omega$

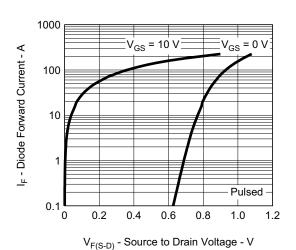
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



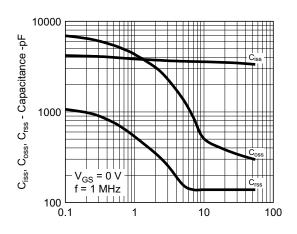
SWITCHING CHARACTERISTICS



SOURCE TO DRAIN DIODE FORWARD VOLTAGE

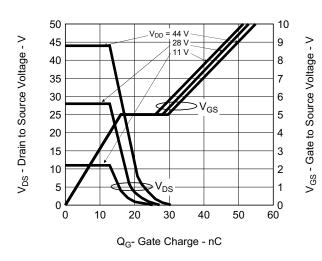


CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE

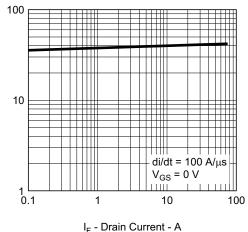


V_{DS} - Drain to Source Voltage - V

DYNAMIC INPUT/OUTPUT CHARACTERISTICS



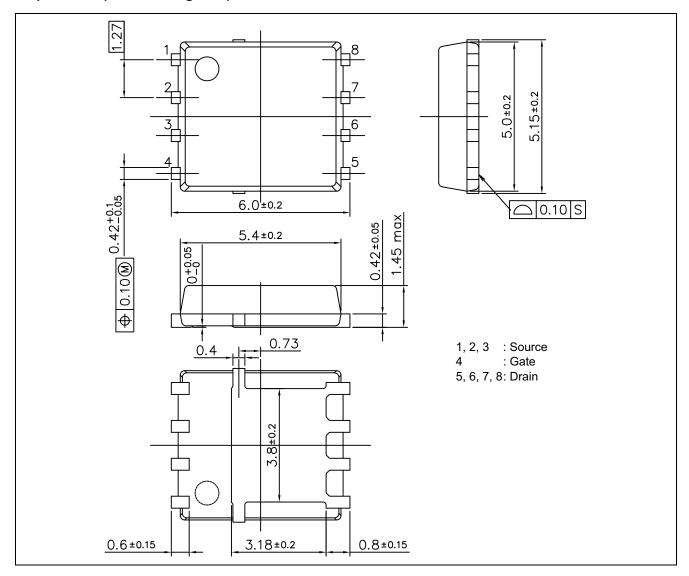
REVERSE RECOVERY TIME vs. **DRAIN CURRENT**



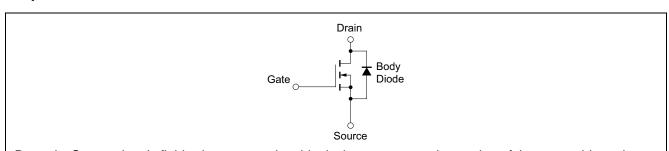
t_{rr} - Reverse Recovery Time - ns

Package Drawing (Unit: mm)

8-pin HSON (Mass: 0.128 g TYP.)



Equivalent Circuit



Remark: Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

Revision History

NP75N055YUK Data Sheet

		Description	
Rev.	Date	Page	Summary
1.00	Feb 08, 2013	_	First Edition Issued

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Renesas Electronics America Inc. 2880 Scott Boulevard Santa Clara, CA 95050-2554, U.S.A. Tel: +1-408-588-6000, Fax: +1-408-588-6130

Renesas Electronics Canada Limited 1101 Nicholson Road, Newmarket, Ontario L3Y 9C3, Canada Tel: +1-905-898-5441, Fax: +1-905-898-3220

Renesas Electronics Europe Limited
Dukes Meadow, Milliboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K
Tel: +44-1628-651-700, Fax: +44-1628-651-804

Renesas Electronics Europe GmbH

Arcadiastrasse 10, 40472 Düsseldorf, Germany Tel: +49-211-65030, Fax: +49-211-6503-1327

Renesas Electronics (China) Co., Ltd. 7th Floor, Quantum Plaza, No.27 ZhiChunLu Ha Tel: +86-10-8235-1155, Fax: +86-10-8235-7679 i. nunLu Haidian District. Beiiing 100083. P.R.China

Renesas Electronics (Shanghai) Co., Ltd.
Unit 204, 205, AZIA Center, No.1233 Lujiazui Ring Rd., Pudong District, Shanghai 200120, China Tel: +86-21-5877-1818, Fax: +86-21-6887-7858 / -7898

Renesas Electronics Hong Kong Limited
Unit 1601-1613, 16/F., Tower 2, Grand Century Place, 193 Prince Edward Road West, Mongkok, Kowloon, Hong Kong
Tel: +852-2868-9318, Fax: +852 2869-9022/9044

Renesas Electronics Taiwan Co., Ltd. 13F, No. 363, Fu Shing North Road, Taipei, Taiwan Tel: +886-2-8175-9600, Fax: +886 2-8175-9670

Renesas Electronics Singapore Pte. Ltd. 80 Bendemeer Road, Unit #06-02 Hyflux Innovation Centre Singapore 339949 Tel: +65-6213-0200, Fax: +65-6213-0300

Renesas Electronics Malaysia Sdn.Bhd. Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No. 18, Jln Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia Tel: +60-3-7955-9390, Fax: +60-3-7955-9510

Renesas Electronics Korea Co., Ltd. 11F., Samik Lavied' or Bldg., 720-2 Yeoksam-Dong, Kangnam-Ku, Seoul 135-080, Korea Tel: 482-2558-3737, Fax: 482-2558-5141

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